



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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Flange Mount Termination 300 Watts, 50Ω



Description

The G300N50W4 is high performance Aluminum Nitride (AlN) flange mount termination. The performance is specifically tuned for ISM band 2.4-2.5GHz and is intended for use in RF heating applications. The termination is also RoHS compliant!

General Specifications

Resistive Element	Thick Film
Substrate	AlN Ceramic
Mounting Flange	Nickel Plated Copper
Operating Temperature	-50 to +150°C (see de rating chart)

Tolerance is $\pm 0.010"$, unless otherwise specified. Designed to meet or exceed applicable portions of MIL-E-5400. **All dimensions in inches.**

Electrical Specifications

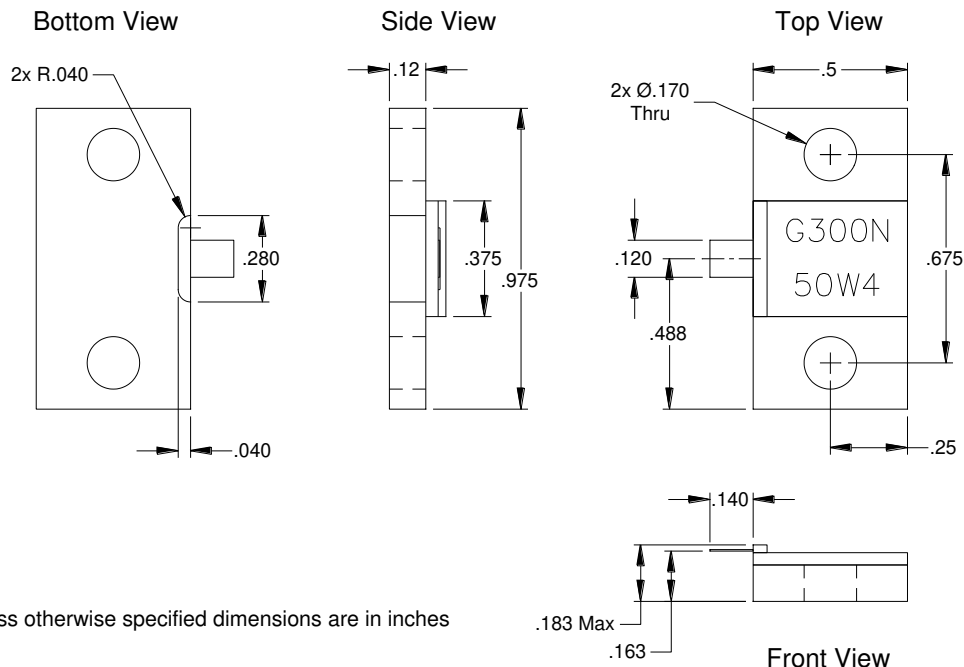
Resistance Value:	50 Ohms Nominal
Power:	300 Watts
Frequency Range:	2.4GHz – 2.5GHz
Return Loss	>25dB:

Specification based on unit properly installed using suggested mounting instructions and a 50 ohm nominal impedance. **Specifications subject to change.**

Features:

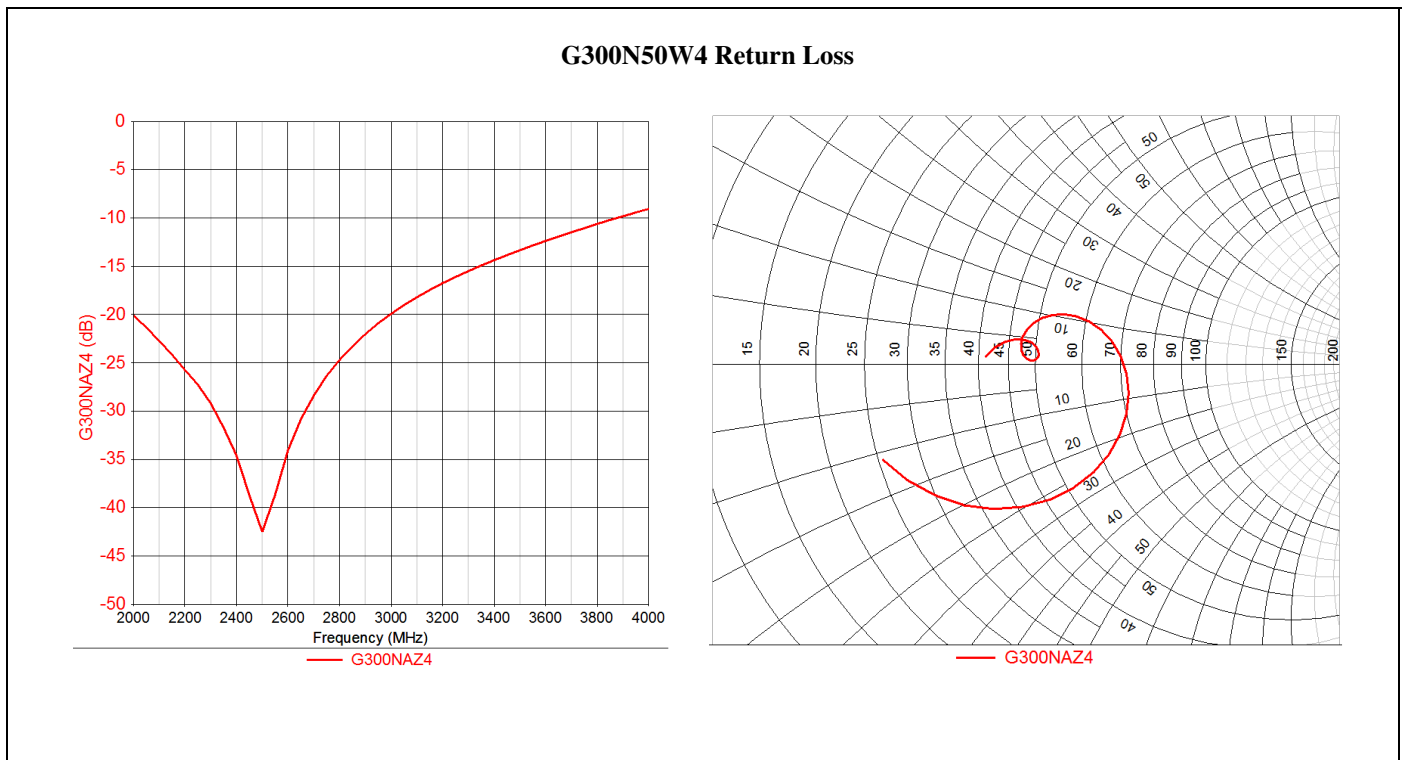
- RoHS Compliant
- 300 Watts
- 2.4 – 2.5 GHz
- AlN Ceramic
- Non-Nichrome Resistive Element
- Low VSWR
- 100% Tested

Outline Drawing

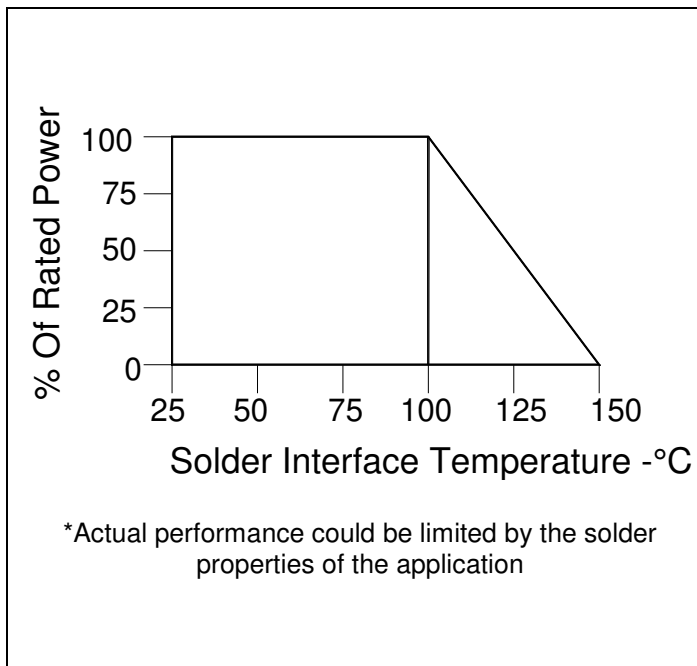


Unless otherwise specified dimensions are in inches

Typical Performance with 30mil thick PCB and recommended Z-bend lead:



Power De-rating:



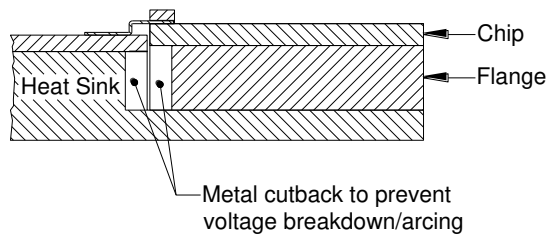
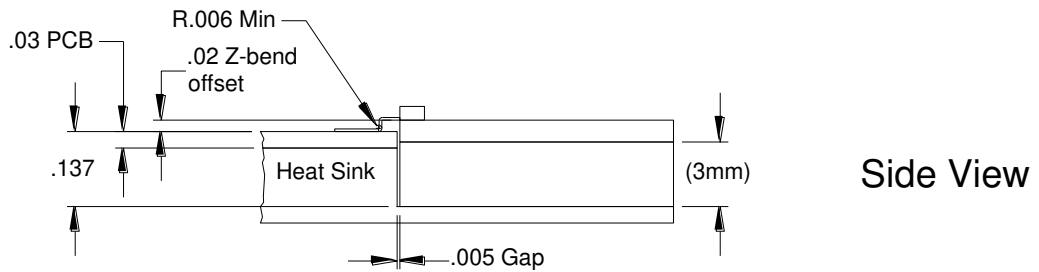
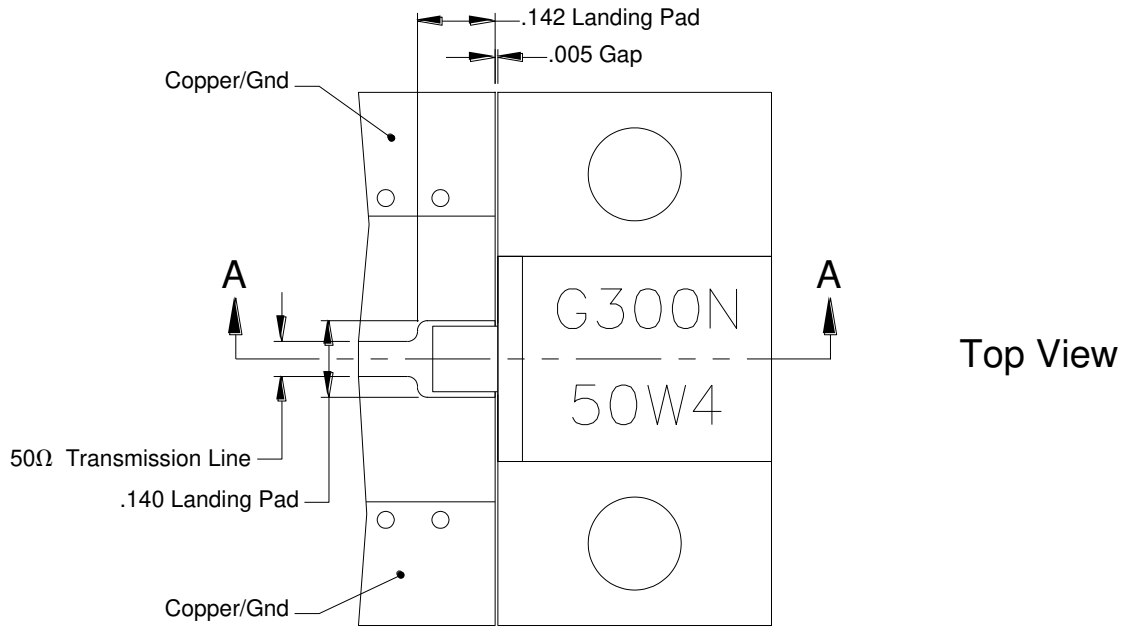
Mounting and Lead Stress Relief Options:

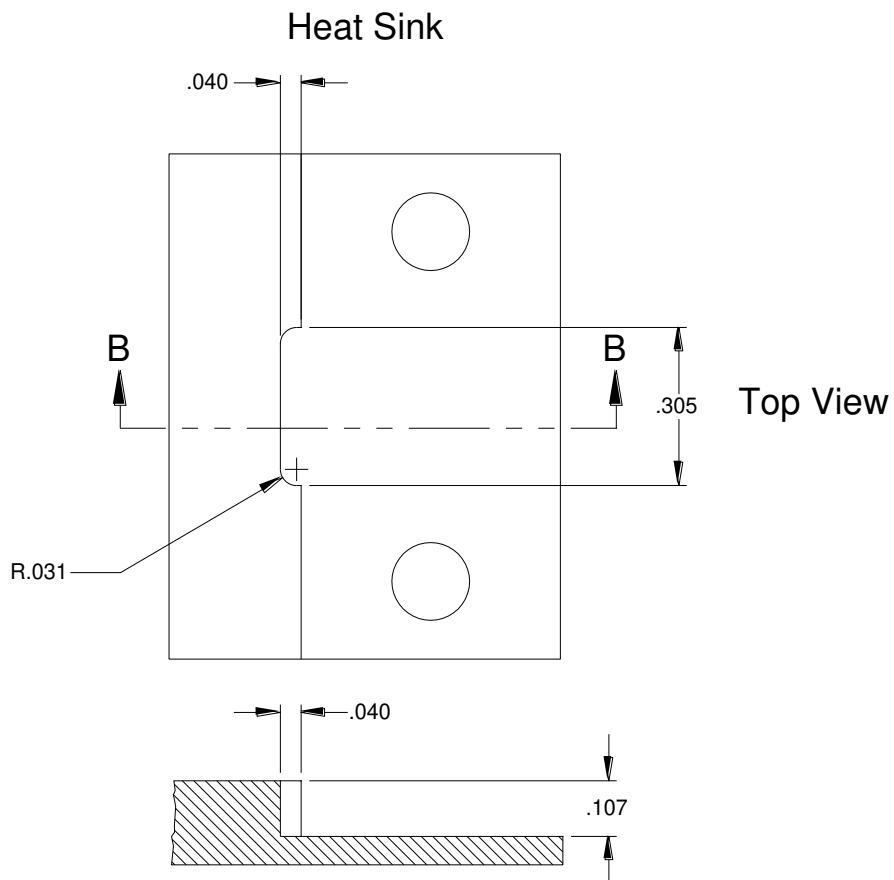
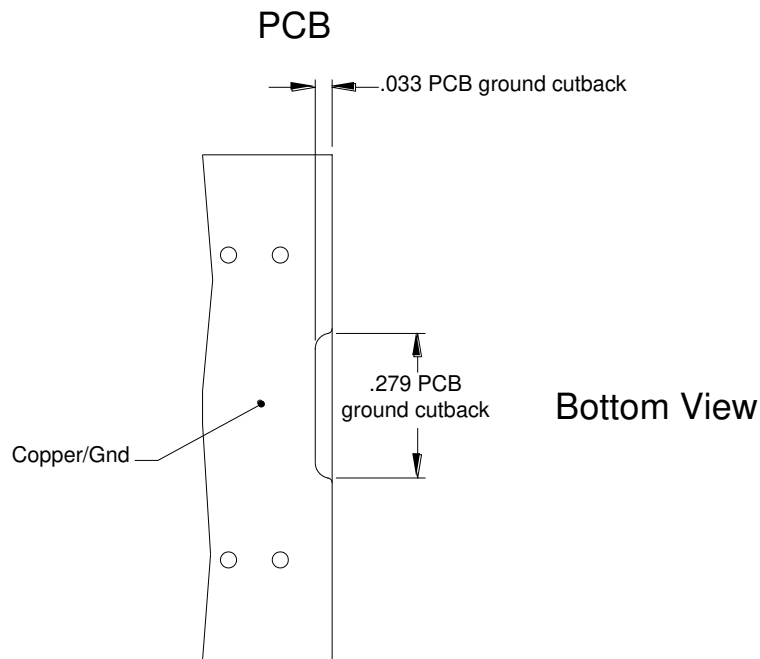
The diagrams illustrate three mounting scenarios. The first two, 'Board lower than lead' and 'Board even with lead', are labeled as 'Suggested stress relief methods' with a 'Scale: None'. The third, 'Board higher than lead', is labeled as a 'Not recommended application' with a 'Scale: None'.

Suggested mounting Procedures:

1. Make sure that the devices are mounted on flat surfaces to optimize the heat transfer
2. Position devices on mounting surface and solder in place using appropriate solder
3. solder leads in place using appropriate solder type with a controlled temperature iron

Recommended Test Fixture Dimensions for 30mil thick Dk 3.5 PCB





Recommended Test Fixture Dimensions for 20mil thick Dk 3.5 PCB

